

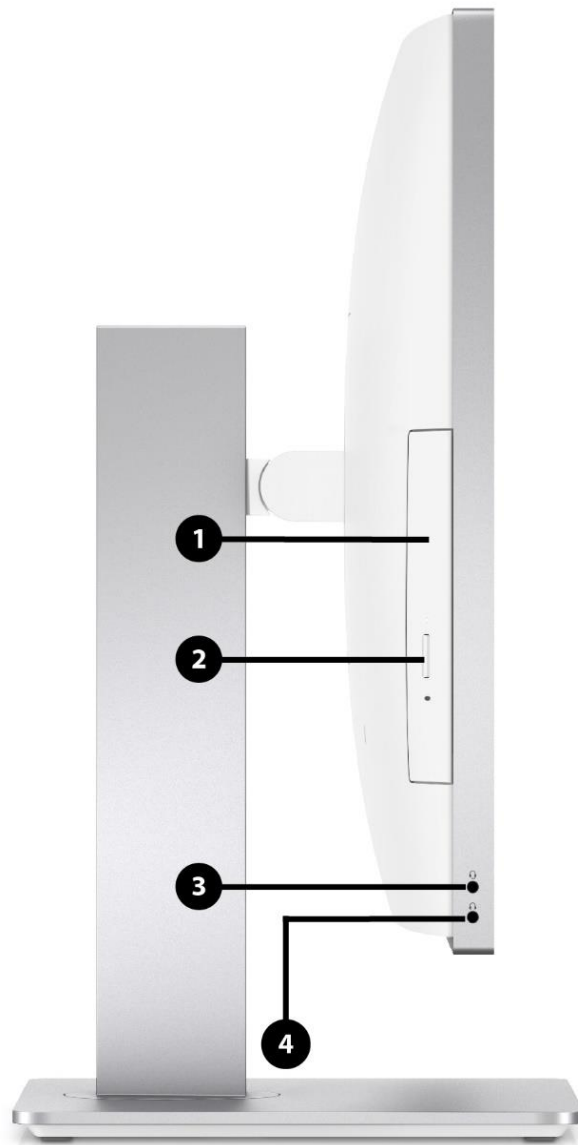
HP EliteOne 800 G4 23.8" Healthcare Edition All-in-One



Front

- 1. Camera (optional)
- 2. FIPS fingerprint reader (optional)
- 3. RFID reader (optional)

HP EliteOne 800 G4 23.8" Healthcare Edition All-in-One

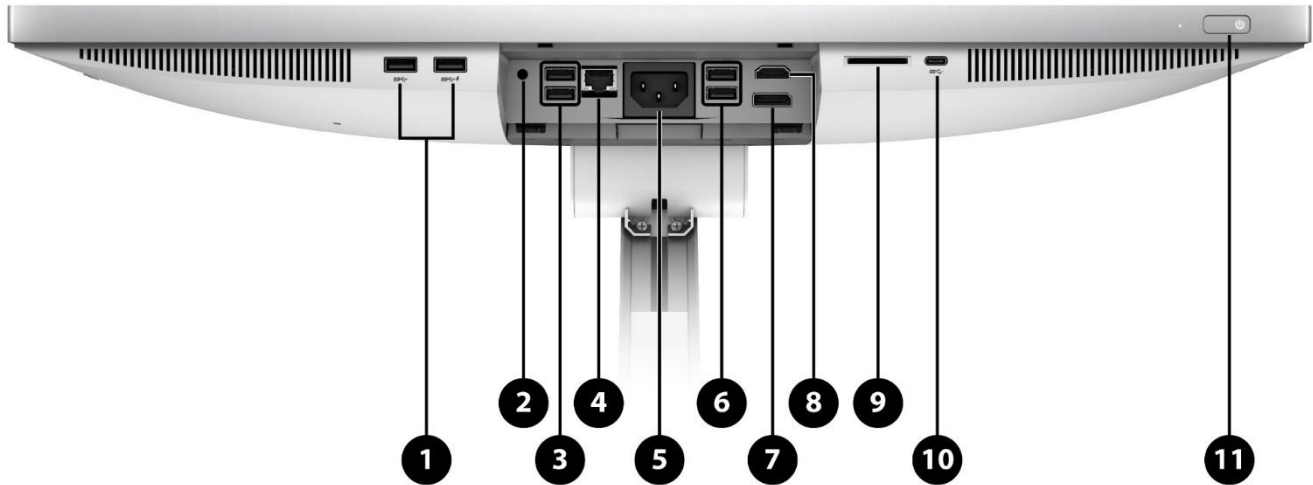


Side

- | | |
|---|---|
| 1. Optical disc drive (optional) | 3. Universal audio jack with CTIA headset support |
| 2. Optical disc drive eject button (optional) | 4. Headphone connector |

Overview

HP EliteOne 800 G4 23.8" Healthcare Edition All-in-One

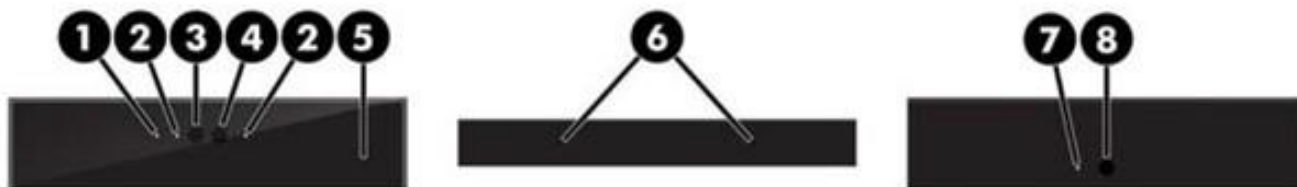


Bottom components and rear ports (behind security cover)

- | | |
|--|--------------------------------------|
| 1. USB 3.1 Gen 2 Type-A ports (2, 1 fast charging) | 7. HDMI 2.0a connector |
| 2. Audio line-out connector | 8. Dual-Mode DisplayPort™ 1.2 (DP++) |
| 3. USB 3.1 Gen 1 Type-A ports (2) | 9. SD card reader 4.0 (optional) |
| 4. RJ-45 (network) jack | 10. USB 3.1 Type-C™ Gen 2 port |
| 5. Power connector | 11. Dual-state power button |
| 6. USB 3.1 Gen 2 Type-A ports (2) wake capable | |

Overview

HP EliteOne 800 G4 23.8" Healthcare Edition All-in-One



Infrared (IR) and dual facing camera (optional)

- | | |
|--------------------------------------|---------------------------------|
| 1. Camera light | 5. Rear camera adjustment wheel |
| 2. IR camera light | 6. Digital microphones |
| 3. Full High Definition (FHD) camera | 7. Camera light |
| 4. IR camera | 8. FHD camera |



Full High Definition (FHD) camera (optional)

- | | |
|-----------------|------------------------|
| 1. Camera light | 3. Digital microphones |
| 2. FHD camera | |

Features

At a Glance

- All-in-One form factor (non-touch)
- Sanitizable with germicidal wipes every shift, every day¹
- Optional, integrated dual-band RFID reader and FIPS-201 compliant fingerprint reader for integrated single sign-on support
- Intel® Q370 chipset
- Intel® 8th generation Core™ processors
- Intel® vPro™ Technology available with Core i5 and Core i7 processors
- Processor support - 65W
- Integrated Intel® UHD Graphics
- Windows 10
- Intel® Ethernet Connection I219LM GbE LOM integrated network connection
- EN 60601-1-2:2015 compliant
- Skype for Business® certified
- Vidyo Ready for telemedicine²
- Optional dual-facing and IR camera supports Windows Hello
- DDR4 Synchronous Dynamic Random Access Memory (SDRAM)
- HP Sure Start Gen4³
- HP Manageability Integration Kit Gen2⁴
- ENERGY STAR® certified. EPEAT® 2019 registered where applicable. EPEAT® registration varies by country. See <http://www.epeat.net> for registration status by country⁶
- CECP Certified
- TCO Edge for AiO
- PC chassis and all internal components and modules are manufactured with low halogen content⁵
- Protected by HP Services, including warranties up to 3-3-3 (terms and conditions vary by country; certain restrictions and exclusions apply)

1. Based on HP's internal analysis as of Nov. 1, 2017 of AiOs tested to simulate up to 10,000 wipes with germicidal towelettes over a 3-year period. See user guide for cleaning instructions. The HP EliteOne 800 G4 23.8 Healthcare Edition AiO is not intended for use in diagnosis, cure, treatment or prevention of disease or other medical conditions.

2. Vidyo software sold separately

3. HP Sure Start Gen4 is available on HP Elite and HP Pro 600 products equipped with Intel® 8th generation processors.

4. HP Manageability Integration Kit Gen2 can be downloaded from <http://www.hp.com/go/clientmanagement>.

5. External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

6. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Features

OPERATING SYSTEMS

Preinstalled Microsoft Windows® 10 Pro¹
Microsoft Windows® 10 Pro (National Academic License)²
Microsoft Windows® 10 Home¹
Microsoft Windows® 10 Home Single Language¹
FreeDos 2.0

Web-supported only Microsoft Windows® 10 Enterprise 64¹

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com/>.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see <https://aka.ms/ProEducation> for Windows 10 Pro Education feature information.

NOTE: Your product does not support Windows 8 or Windows 7

In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on <http://www.support.hp.com>

PROCESSORS

8th Gen Intel® Core™ Processor

Intel® Core™ i7 8700 with Intel® UHD Graphics 630 (3.2 GHz, up to 4.6 GHz with Intel® Turbo Boost, 12 MB cache, 6 cores)

Intel® Core™ i7+ 8700 processor (Core i7 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (3.2 GHz, up to 4.6 GHz with Intel® Turbo Boost, 12 MB cache, 6 cores)

Intel® Core™ i5 8600 with Intel® UHD Graphics 630 (3.1 GHz, up to 4.3 GHz with Intel® Turbo Boost, 9 MB cache, 6 cores)

Intel® Core™ i5+ 8600 processor (Core i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (3.1 GHz, up to 4.3 GHz with Intel® Turbo Boost, 9 MB cache, 6 cores)

Intel® Core™ i5 8500 with Intel® UHD Graphics 630 (3.0 GHz, up to 4.1 GHz with Intel® Turbo Boost, 9 MB cache, 6 cores)

Intel® Core™ i5+ 8500 processor (Core i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 630 (3.0 GHz, up to 4.1 GHz with Intel® Turbo Boost, 9 MB cache, 6 cores)

Intel® Core™ i3 8300 with Intel® UHD Graphics 630 (3.7 GHz, 8 MB cache, 4 cores)

Intel® Core™ i3 8100 with Intel® UHD Graphics 630 (3.6 GHz, 6 MB cache, 4 cores)

Intel® Pentium® Gold G5600 with Intel® UHD Graphics 630 (3.9 GHz, 4 MB cache, 2 cores)

Intel® Pentium® Gold G5500 with Intel® UHD Graphics 630 (3.8 GHz, 4 MB cache, 2 cores)

Intel® Pentium® Gold G5400 with Intel® UHD Graphics 610 (3.7 GHz, 4 MB cache, 2 cores)

Intel® Celeron® G4900 with Intel® UHD Graphics 610 (3.1 GHz, 2 MB cache, 2 cores)

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel® and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

NOTE: Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

NOTE: Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

Features

CHIPSET

Intel® Q370

GRAPHICS

Integrated Intel® Graphics

Intel® UHD Graphics 630 (integrated on 8th gen Core i7/i5/i3, Pentium® Gold G5600, G5500)

Intel® UHD Graphics 610 (integrated on 8th Pentium® Gold G5400, Celeron® G4900)

DISPLAY FEATURES

HP EliteOne 800 G4 Healthcare Edition 23.8-in FHD Display

23.8" diagonal IPS widescreen WLED backlit LCD (1920 x 1080)

Non-Touch

Glass covered display

DISPLAY PANEL SPECIFICATIONS

23.8" diagonal IPS widescreen WLED backlit anti-glare LCD (1920 x 1080)

Type	IPS WLED Backlit LCD
Active area (mm)	527.04 x 296.46
Native Resolution (HxV)	1920 x 1080
Aspect ratio	16:09
Pixel pitch (HxV)(mm)	0.2745 x 0.2745
Contrast ratio (typical)	1000:1
Brightness (typical)	250 nits
Viewing angle (typical) (HxV)	178 ° x 178 °
Backlight lamp life (to half brightness)	30,000 hours minimum
Color support	Over 16 million colors
Color gamut (typical)	NTSC 72%
Anti-glare	Yes
Default color temperature	Warm (6500K)

NOTE: All performance specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Features

STORAGE AND DRIVES¹

2.5 inch 7.2k RPM Hard Disk Drives

500GB SATA

1TB SATA

2.5 inch Solid State Hybrid Drives (SSHD)

500GB 5400RPM 2.5in 8GB Hybrid

1TB 5400RPM 2.5in 8GB Hybrid

2TB 5400RPM 2.5in 8GB Hybrid

2.5 inch 5.4k RPM Hard Disk Drives

2TB SATA

2.5 inch Self-encrypting Drives (SED HDD)

500GB 7200RPM 2.5in SED OPAL 2

500GB 5400RPM 2.5in Federal Information Processing Standard (FIPS) SED

2.5 SATA SSD Drives

128GB SATA TLC SSD

256GB SATA TLC SSD

512GB SATA TLC SSD

2.5 inch Self-encrypting Drives (SED SSD)

256GB TLC SED SSD OPAL 2 Drive

512GB TLC SED SSD OPAL 2 Drive

256GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED

512GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED

PCIe NVMe SSD Drives

256GB PCIe NVMe TLC SSD

256GB PCIe NVMe TLC SSD 2nd

512GB PCIe NVMe TLC SSD

512GB PCIe NVMe TLC SSD 2nd

1TB PCIe NVMe TLC SSD

1TB PCIe NVMe TLC SSD 2nd

128GB PCIe NVMe SSD

128GB PCIe NVMe SSD 2nd

256GB PCIe NVMe SSD

256GB PCIe NVMe SSD 2nd

512GB PCIe NVMe SSD

512GB PCIe NVMe SSD 2nd

PCIe NVMe Self-encrypting Drives (PCIe NVMe SED SSD)

256GB PCIe NVMe TLC SED SSD OPAL 2 Drive

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for the system recovery software.

Features

MEMORY

Maximum

32GB (16GB/slot)

Memory Slots

2 SODIMMs

DDR4-2666 (Transfer rates up to 2666 MT/s)

Dual channel support

Customer accessible/upgradeable

Configurations

4 GB (1 x 4 GB)

8 GB (2 x 4 GB)

8 GB (1 x 8 GB)

16 GB (2 x 8 GB)

16 GB (1 x 16 GB)

32 GB (2 x 16 GB)

Intel® Optane Memory 16GB SSD (cache)

NOTE: Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

NETWORKING

Wireless LAN

Intel® 9560 802.11b/g/n/a/ac 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-vPro™

Intel® 9560 802.11b/g/n/a/ac 2x2 Wi-Fi +Bluetooth® M.2 Combo Card vPro™

Realtek RTL8822BE ac 2x2 Wi-Fi +Bluetooth® M.2 Combo Card

Realtek ac 1x1 +Bluetooth® M.2 Combo Card (2230 PCI-e+USB)

Ethernet (RJ-45) Integrated

Intel® I219LM Gigabit Network Connection LOM (standard)

NOTE: Wireless LAN is optional and must be bought at purchase

NOTE: Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

NOTE: The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the device to communicate with other 802.11ac WLAN devices.

Features

AUDIO/MULTIMEDIA

Audio

Integrated Conexant CX5001 codec - up to 24-bit PCM
High performance integrated stereo speakers(2watt)

High Definition Audio

Integrated
Conexant CX5001

Webcams & Mic

Pop-up camera - 2MP FHD camera, up to 30 frames/sec, discrete dual array microphone (Fixed 2MP FHD 1080p)(maximum resolution of 1920 x1080)(optional)

Pop-up camera - 2MP FHD camera with IR camera front-facing and 2nd rear-facing 2MP camera discrete dual array microphone (Dual Camera 480P IR+1080P RGB Fixed/2MP FHD 1080P Fixed)(maximum resolution of 1920x1080)(optional)
IR camera (optional) supports Win10 Hello

NOTE: Universal Audio Jack with CTIA headset support (re-taskable for headphone/line out/microphone in/line in)

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard and Mouse Combos

HP Premium Wireless Keyboard and Mouse
HP USB Keyboard and Mouse Healthcare Edition
HP Wireless Business Slim Keyboard and Mouse
HP USB Keyboard and Mouse

Keyboards

HP USB Collaboration Wired Keyboard
HP Collaboration Wireless Keyboard
HP USB Business Slim Keyboard
HP USB Business Slim Grey Keyboard
HP USB Business Slim CCID SmartCard Keyboard
HP USB Business Slim Antimicrobial Keyboard*
HP USB Wired Keyboard
HP Wired Keyboard EPEAT®
HP USB PS/2 Washable Standalone Wired Keyboard
HP USB Conferencing Wired Keyboard

Mice

HP USB 1000dpi Laser Mouse
HP Grey V2 Mouse
HP USB Mouse
HP USB Antimicrobial Mouse*
HP USB Hardened Mouse
HP Washable Wired Mouse USB PS/2
HP Optical USB Mouse

Other

HP Mouse Pad
HP EliteOne G4 AiO Dust Filter

Features

Adapters and Cables

HP DisplayPort Cable
HP DisplayPort to DVI-D Adapter
HP DisplayPort to HDMI True 4K Adapter
HP DisplayPort to VGA Adapter
HP DVI Cable
HP USB Type-C™ to Type-A Hub
HP USB to Serial Port Adapter
HP USB-C™ to USB 3.0 Adapter
HP Type-C to DisplayPort Adapter

Headsets

HP Business Headset v2

*China Only

HP BIOSPHERE

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability – HP BIOS provides several technologies that help integrate the HP EliteOne 1000 Business PC into the enterprise, such as PXE, remote configuration, remote control, and BIOS (F10) Setup support for 14 languages.
- Network firmware updates – Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability – HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.6
- Absolute Persistence agent – For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management – The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance – Industry leading acoustic emissions across the range of operating conditions.
- Serviceability – HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery – HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within Windows (HPBIOSUPDREC), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.
- Additional HP BIOS Features:
 - Power-On password – Helps prevent an unauthorized user from powering on the system.
 - Administrator password – Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Maximum Power Savings feature is enabled below features are turned off:
 - Power to expansion connectors / slots
 - Wake events other than power buttons (such as wake on LAN)
 - USB charging ports
- HP SureStart

Features

- BIOS Integrity checking – Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while On.
 - Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
 - Protecting beyond BIOS – Integrity checking and repair is extended to other data that should be protected such as network configuration parameters (network name), platform specific information (i.e. system IDs) and other code the system needs to boot.
 - Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.
-

SOFTWARE AND SECURITY

BIOS

HP BIOSphere Gen4 ¹⁷

HP DriveLock & Automatic DriveLock

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Secure Erase ¹⁸

Absolute Persistence Module ¹⁹

Pre-boot Authentication

HP Wireless Wakeup

Software

HP Native Miracast Support ¹⁵

HP LAN-Wireless Protection

HP Hotkey Support - CMIT

HP Recovery Manager

HP Jumpstart

HP Support Assistant ²¹

HP Noise Cancellation Software

Buy Office

Manageability Features

HP Driver Packs ²²

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen2 ²³

Ivanti Management Suite ²⁴

HP Collaboration Keyboard

Features

Client Security Software

HP Client Security Suite Gen4 including: ²⁵

HP Security Manager ²⁶ (including Credential Manager, HP Password Manager, HP Spare Key)

Power On Authentication

HP Fingerprint Sensor ³¹

HP Device Access Manager

HP Power On Authentication

Windows Defender ²⁷

Security Management

HP BIOSphere Gen4 ¹⁷

HP DriveLock & Automatic DriveLock

BIOS Update via Network

Secure Erase ¹⁸

Pre-boot Authentication

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified) ³²

SATA 0,1 port disablement (viaBIOS)

RAID configurations ³³

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click ³⁴

HP Sure Start Gen4 ³⁰

15. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming

17. HP BIOSphere Gen4 features may vary depending on the PC platform and configurations requires 8th Gen Intel® processors.

18. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

<http://www.absolute.com/company/legal/agreements/computrace-agreement>. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

21. HP Support Assistant requires Windows and Internet access.

22. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

23. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>

24. Ivanti Management Suite subscription required.

25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.

26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

27. Windows Defender Opt In, Windows 10, and internet connection required for updates..

30. HP Sure Start Gen4 is available on HP EliteBook products equipped with Intel® 8th generation processors

31. HP Fingerprint Sensor sold separately or as an optional feature.

32. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

33. RAID configuration is optional and does require a second hard drive.

Features

34. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed. Check <http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW> for all compatible platforms as they become available.

POWER

Power Supply

Internal

Internal 180W

WEIGHTS & DIMENSIONS

Weight

Product Weight Unboxed

Without Stand

6.4 – 7kg, 14.1 – 15.4 lbs

Adjustable height stand:

9.5 – 9.53kg, 20.79 – 21.01 lbs

Dimensions (W x D x H)

Products Dimensions

Without Stand

540.4 x 54 x 341.96 mm

21.24 x 2.1 x 13.5 in

Adjustable height stand (0 degrees)

540.4 x 220.16 x 468 mm

21.24 x 8.67 x 18.43 in

ENVIRONMENTAL AND INDUSTRY

UNIT ENVIRONMENTAL AND OPERATING CONDITIONS

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range

Operating: 50° to 95° F (10° to 35° C)*

Non-operating: -22° to 140° F (-30° to 60° C)

Relative Humidity

Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)



Features

Maximum Altitude (unpressurized)

Operating: 5000m
Non-operating: 50000ft (15240 m)

NOTE: Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Eco-Label Certifications & declarations	<p>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:</p> <ul style="list-style-type: none"> • IT ECO declaration • US ENERGY STAR® • EPEAT® 2019 registered where applicable. EPEAT® registration varies by country. See http://www.epeat.net for registration status by country*. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options. <p>*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.</p>		
System Configuration	<p>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Desktop model is based on a "Typically Configured Desktop".</p>		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	21.98 W	22.24W	21.69 W
Normal Operation (Long idle)	11.35 W	11.60 W	11.22W
Sleep	4.10 W	4.11 W	3.98 W
Off	0.73 W	0.74 W	0.69 W
	<p>NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.</p>		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	75 BTU/hr	76 BTU/hr	74 BTU/hr
Normal Operation (Long idle)	39 BTU/hr	40 BTU/hr	38 BTU/hr
Sleep	14 BTU/hr	14 BTU/hr	13 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr
	<p>NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.</p>		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)		Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	3.2		20
Fixed Disk – Random writes	3.5		28
Longevity and Upgrading	<p>This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:</p>		

Features

	Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.		
Batteries	<p>This battery(s) in this product comply with EU Directive 2006/66/EC</p> <p>Batteries used in the product do not contain: Mercury greater the 1ppm by weight Cadmium greater than 20ppm by weight</p> <p>Battery size: CR2032 (coin cell) Battery type: Lithium</p>		
Additional Information	<ul style="list-style-type: none"> • This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. • This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. • This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). • This product is in compliance with the IEEE 1680.1-2018 EPEAT® Status varies by country. Visit www.epeat.net for more information. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options • Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. • This product contains 0% post-consumer recycled plastic (by wt.) • This product is 95.1% recycle-able when properly disposed of at end of life. 		
Packaging Materials	External:	PAPER/Corrugated	1419 g
	Internal:	PLASTIC/EPE (Expanded Polyethylene)	694 g
		PLASTIC/Polyethylene low density	94 g
Material Usage	<p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):</p> <ul style="list-style-type: none"> • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Hydrocarbons • Chlorinated Paraffins • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBBEs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) 		
End-of-life Management and Recycling	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest		

Features

	<p>HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>
<p>HP Inc. Corporate Environmental Information</p>	<p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p>

PORTS/SLOTS

Rear I/O Connectors

- (2) USB 3.1 Gen 1 Type A w/ S4/S5 Wake
- (3) USB 3.1 Gen 2 Type A
- (1) USB 3.1 Gen 2 Type A w/ BC 1.2
- (1) USB 3.1 Gen 2 Type-C DFP w/ 3.0A w/ BC1.2
- (1) LAN RJ45
- (1) DisplayPort 1.2
- (1) HDMI 2.0a
- (1) Audio Line-Out
- (1) SD Card Reader 4.0

Left I/O Connectors

- (1) Headphone
- (1) Headset - CTIA UAJ Headset w/o Virtual OMTP

M.2 Socket

- (1) M.2 Socket 1 Type 2230-E
- (2) M.2 Socket 3 Type 2230/80-M

Storage

- (2) SATA Power/Data Combo

Features

SERVICE AND SUPPORT

On-site Warranty ¹⁶: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day ¹⁷ service for parts and labor and complimentary limited technical support. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack. ¹⁸ To choose the right level of service for your HP product, visit HP Care Pack Central: <http://www.hp.com/go/cpc>

16. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

17. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

18. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

ENERGY STAR® certified; EPEAT® 2019 registered where applicable. EPEAT® registration varies by country. See www.epeat.net for registration status by country

NOTE: Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit <http://www.epeat.net> for more information.

Technical Specifications – Card Reader

RFID CARD READER

Operating Frequencies	125 kHz, 13.56 MHz
Read Height	1 in (Typical)
Device Class	HID
Protocol	USB HID
NFC RF Standards (in reading CSN)	ISO/IEC 14443 A, ISO/IEC 14443 B ISO/IEC 15693
NFC Forum Support	Tag Type 1, Type 2, Type 3, and Type 4 in reading CSN
Raw RF Data Rates	Low-frequency Cards: 1,2050 to 7,812 bps High-frequency Cards: 106 to 848 bps AWID (RDR-698x Compatible) Cardax UID (RDR-6C8x Compatible) CASI-RUSCO (GE Security, UTC) (RDR-628x Compatible) CDVI COTAG Deister UID DIGITAG Dimpna UID EM 410x (RDR-6E8x Compatible) EM 410x Alternate Farpointe Data (Pyramid) PSC-1 26 Bit (RDR-647x Compatible) Farpointe Data (Pyramid) UID GProx-II ID GProx-II UID (IRDR-6G8x Compatible) HID Prox (RDR-608x Compatible) HID Prox UID Hitag 1 & S (RDR-6H8x Compatible) Hitag 1 & S Alternate Hitag 2 (RDR-6H8x Compatible) Hitag 2 Alternate ID Teck (RDR-6A8x Compatible) ID Teck Alternate (128 bits) Indala ASP 26 bit (Motorola) (RDR-638x Compatible) Indala ASP UID (Motorola) Indala ASP+ UID (Motorola) IO Prox (Kantech) (RDR-678x Compatible) Isonas Keri NXT UID Keri PSC-1 26 Bit: (RDR-647x Compatible) Keri UID (RDR-6K8x Compatible) Nedap NexKey, Quadrakey, KeyMate, 2SmartKey (Honeywell) Nexwatch (Honeywell) (RDR-6N8x Compatible) Paradox Postech Pyramid (Farpointe Data) PSC-1 26 Bit Pyramid (Farpointe Data) UID Radio Key (Secura Key -02) RKCx-02 (RDR-6Z8x Compatible) ReadyKey Pro UID RDR-6R8x Compatible) Rosslare Russwin UID Secura Key -01 RKCx-01
Card Types Supported – 125 kHz	

Technical Specifications – Card Reader

Card Types Supported – 13.56 MHz	CEPAS
	e-TAG
	Felica (NFC Type 3)
	HID iCLASS
	I-Code
	ISO 14443B
	I-tag
	Legic Advant
	MIFARE Classic (32 bits)
	MIFARE DESFire
	MIFARE DESFire EV1
	MIFARE Plus
	MIFARE Ultralight
	my-d CSN (Infinion)
	NFC Type 1
	NFC Type 2
	NFC Type 4
NTWare	
Oyster	
RDR-758x Equivalent (iCLASS, ISO 14443A, ISO 15693)	
Tag-It (Texas instruments)	
Card Types Supported – 13.56 MHz ID (with HID SE Processor SIM)	HID iCLASS ID
	HID iCLASS SE
	HID iCLASS Seos

NOTE: Dual-band RFID reader and fingerprint reader sold together as a configurable option

Technical Specifications – Cleaning Care Guide

CLEANING CARE GUIDE

Please refer to the HP EliteOne 800 G4 23.8 Healthcare Edition All-in-One Business PC user guide for instructions on cleaning this computer. Here are additional instructions for cleaning with specific germicidal wipes.

First turn off the computer to prevent electric shock or damage to components.

- Disconnect AC power
- Disconnect all powered external devices

Examine the computer for any visible soiling and then wipe the exterior of the computer with a soft, water-dampened cloth to remove the soil as needed.

- The cloth should be moist but not wet. Water dripping into the ventilation or other points of ingress can cause damage.

Next, clean the computer using any of the ready-to-use germicidal wipes that contain the below chemical solutions.

- Remember to start with the display, then wipe the rest of the computer and finish with any flexible cables
- Allow the unit to air-dry before use

(Refer to the directions for use provided by the manufacturer of the wipes)

Ready-to-use cleaning wipe solutions include:

• Solution 1

- Benzyl-C12-18-alkyldimethyl ammonium chlorides: <0.1%
- Quaternary ammonium compounds, C12-14-alkyl[(ethylphenyl)methyl]di methyl, chlorides: <0.1%

• Solution 2

- Isopropanol: 10-20%
- 2-Butoxyethanol: <5%
- Quaternary ammonium compounds, C12-18-alkyl [(ethylphenyl) methyl] dimethyl, chlorides: <0.5%
- Benzyl-C12-18-alkyldimethyl ammonium chlorides: <0.5%

• Solution 3

- Quaternary ammonium compounds, C12-18-alkyl [(ethylphenyl) methyl] dimethyl, chlorides: <0.5%
- Benzyl-C12-18-alkyldimethyl ammonium chlorides: <0.5%

• Solution 4

- Isopropyl alcohol: 55.000%
- Alkyl dimethyl benzyl ammonium chlorides: 0.250%
- Alkyl (68% C12, 32% C14) dimethyl ethylbenzyl ammonium chloride: 0.250%

• Solution 5

- Isopropanol: 10-20%
- Ethylene Glycol Monobutyl Ether (2-Butoxyethanol): 1-5%
- Diisobutylphenoxyethoxyethyl dimethyl benzyl ammonium chloride: 0.1-0.5%

• Solution 6

- Sodium hypochlorite 0.1%–1.0%

• Solution 7

- Cellulose: 10-30%
- Ethyl alcohol: 0.10-1.00%

• Solution 8

- Isopropyl alcohol: 30-40%
- Water: 60-70%

Do not use cleaners that contain any petroleum based materials such as benzene, thinner, or any volatile substance to clean the screen or cabinet. These chemicals may damage the computer.

Occasionally clean air vents on all vented sides of the computer. Lint and dust can block the vents and limit the airflow.

DISCLAIMER: Solution tested as of December 4, 2017; chemical composition is subject to change.

Technical Specifications – Storage

STORAGE AND DRIVES

HP 500 GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity	500 GB
Rotational Speed	7,200 rpm
Interface	SATA 6 Gb/s
Buffer Size	16 MB
Logical Blocks	976,773,169
Seek Time	13 ms (Average)
Height	0.267 in/6.8 mm (nominal)
Width	2.75 in/70 mm (nominal)
Operating Temperature	41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for the system recovery software.

HP 1 TB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity	1 TB
Rotational Speed	7,200 rpm
Interface	SATA 6 Gb/s
Buffer Size	32 MB
Logical Blocks	1,953,525,169
Seek Time	13 ms (Average)
Height	0.374 in/9.5 mm (nominal)
Width	2.75 in/70 mm (nominal)
Operating Temperature	41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for the system recovery software.

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Capacity	500 GB
Rotational Speed	5,400 rpm
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash
Interface	SATA 6 Gb/s
Buffer Size	64 MB
NAND Flash	8GB
Seek Time	13 ms (Average)
Height	0.267 in/6.8 mm (nominal)
Width	2.75 in/70 mm (nominal)
Operating Temperature	41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Technical Specifications – Storage

HP 1 TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)	Capacity	1 TB
	Rotational Speed	5,400 rpm
	Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash
	Interface	SATA 6 Gb/s
	Buffer Size	64 MB
	NAND Flash	8 GB
	Seek Time	13 ms (Average)
	Height	0.374 in/9.5 mm (nominal)
	Width	2.75 in/70 mm (nominal)
Operating Temperature	41° to 131° F (5° to 55° C)	

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software..

HP 2 TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)	Capacity	2 TB
	Rotational Speed	5,400 rpm
	Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash
	Interface	SATA 6 Gb/s
	Buffer Size	128 MB
	NAND Flash	8GB
	Seek Time	13 ms (Average)
	Height	0.374 in/9.5 mm (nominal)
	Width	2.75 in/70 mm (nominal)
Operating Temperature	41° to 131° F (5° to 55° C)	

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software..

HP 2 TB 5.4K SATA 6.0Gb/s 2.5" Hard Disk Drive	Capacity	2 TB
	Rotational Speed	5,400 rpm
	Interface	SATA 6 Gb/s
	Buffer Size	128 MB
	Logical Blocks	3,907,050,336
	Seek Time	13 ms (Average)
	Height	0.374 in/9.5 mm (nominal)
	Width	2.75 in/70 mm (nominal)
	Operating Temperature	41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Technical Specifications – Graphics

GRAPHICS

Intel® UHD Graphics (integrated)

DisplayPort™

HDMI

Memory

Maximum Color Depth

Graphics/Video API Support

Multimode capable; supports HDCP 2.2, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)

Supports HDMI 2.0a features

The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Up to 10 bits/color

HEVC 10b Enc/Dec HW

VP9 10b Dec HW

HDR

Rec. 2020

DX12

Display Output chart.

Resolution	Refresh Rate	VGA (Using HP DP to VGA adapter)	DVI-D (Using HP DP to DVI-D adapter)	DisplayPort™	HDMI	Standard
640 x 480	60, 75, 85	X	X	X	X	VESA DMT, CVT 0.31M3
720 x 400	70	X	X	X	X	IBM VGA
800 x 600	60, 75, 85	X	X	X	X	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	X	X	X	X	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	X	X	X	X	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	X	X	X	X	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	X	X	X	X	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	X	X	X	X	VESA DMT
1280 x 960	60, 75, 85	X	X	X	X	VESA DMT
1280 x 1024	60, 75, 85	X	X	X	X	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	X	X	X	X	VESA DMT
1440 x 900	60, 60RB	X	X	X	X	VESA DMT
1600 x 900	60, 60RB, 75, 85	X	X	X	X	VESA DMT
1680 x 1050	60, 60RB	X	X	X	X	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	X	X	X	X	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1080	75			X	X	CVT-RBv2 (2.07M-R)
1920 x 1080	100			X	X	CVT-RBv2 (6.14M-R)
1920 x 1080	120			X	X	SMPTE 274M

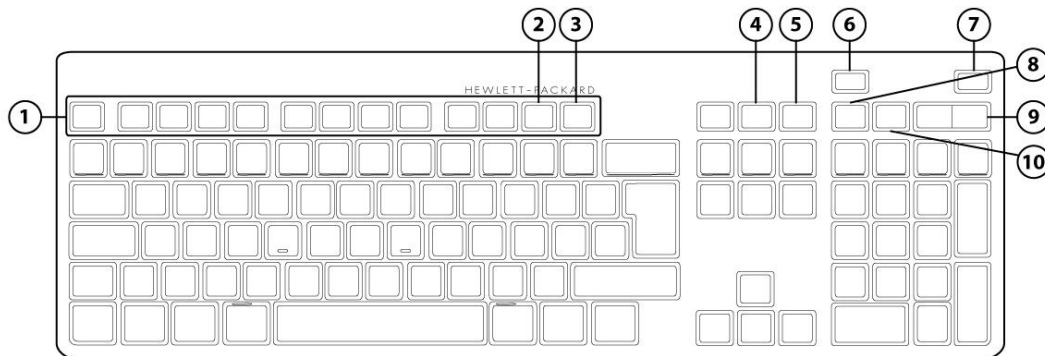
Technical Specifications – Graphics

1920 x 1080	144			X	X	SMPTE 274M
1920 x 1200	60, 60RB	X ¹	X	X	X	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60	X	X	X	X	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85			X	X	VESA DMT, CVT 2.76M3
1920 X 1600	59.95			X	X	CVT-RBv2 (Not CVT Standard Aspect Ratio)
2048 x 1536	60			X	X	CVT 3.15M3
2560 x 1440	59.951			X	X	CVT 3.69M9-R
2560 x 1600	60, 60RB			X	X	VESA DMT, CVT 4.10MA/4.10MA-R
3440 x 1200	60			X	X	CVT-4.61M-R
3440 x 1440	49.987			X	X	CVT-RB v1
3440 x 1440	59.973			X	X	CVT-RB v1
3440 x 1440	60			X	X	Samsung Custom
3440 x 1440	100			X	X	CVT-RBv2 (4.95M-R)
3440 x 1440	120			X	X	CVT-RBv2 (4.95M-R)
3840 x 1600	30			X	X	CVT-RBv2 (6.14M-R)
3840 x 1600	59.994			X	X	CVT-RBv2
3840 x 2160	24			X	X	SMPTE 274M
3840 x 2160	25			X	X	SMPTE 274M
3840 x 2160	30			X	X	SMPTE 274M
3840 x 2160	29.981			X	X	CVT-RB v1
3840 x 2160	50			X	X	SMPTE 274M
3840 x 2160	59.997			X	X	CVT-RBv1 (8.29M9-R)
3840 x 2160	60			X	X	SMPTE 274M
4096 x 2160	24			X	X	SMPTE 274M
4096 x 2160	25			X	X	SMPTE 274M
4096 x 2160	30			X	X	SMPTE 274M
4096 x 2160	50			X	X	SMPTE 274M
4096 x 2160	59.94			X	X	CVT-RBv2
4096 x 2160	60			X	X	CVT-RBv2
1920 x 1080	60		X	X	X	VESA (SMPTE 274M)

NOTE: Other refresh rates and resolutions may also work, but have not been validated.
 >60Hz refresh rates only for analog (VGA) signaling
 1 - 60Hz Reduced Blanking only.

INPUT/OUTPUT DEVICES

HP Conferencing Keyboard



- | | |
|--|--|
| <ul style="list-style-type: none"> 1. Function Keys 2. F11 Lync or Skype for Business Contact list ¹ 3. F12 Lync or Skype for Business Calendar² 4. Share Screen 5. Stop Webcam | <ul style="list-style-type: none"> 6. End/Decline a Call 7. Answer a Call 8. Microphone Mute 9. Volume Up/Down 10. Audio Mute |
|--|--|

1. [Microsoft Lync 2013, or Skype for Business Contact list](#)

2. [Microsoft Lync 2013, or Skype for Business Calendar](#)

HP USB Premium Keyboard

Physical Characteristics	Keys	104, 105 layout (depending upon country)
	Dimensions (L x W x H)	17.04 x 5.55 x 0.52 in (433 x 141 x 13.2 mm)
	Weight	1.54 lb (698g)
	Operating voltage	5 VDC, +/-5%
	Power consumption	35mA (All LED on)
Electrical	System interface	USB Type A plug connector
	ESD	Contact Discharge: 8 KV Air Discharge: 15 KV
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Mechanically compliant
	Keycaps	Low-profile design
	Switch actuation	60±10g nominal peak force with tactile feedback
Mechanical	Switch life	10 million keystrokes (Life tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)

Technical Specifications – Power

	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
Environmental	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence
	Approvals	UL, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC
	Ergonomic compliance	TUVGS
	Kit contents	Keyboard, QSP
	Warranty Card	Product Notice
Skylab USB wired Keyboard		
	Keys	104, 105, 106, 107, 109 layout (depending upon country)
Physical Characteristics	Dimensions (L x W x H)	436.9*137.7*20.4mm
	Weight	615g
	Operating voltage	4.4-5.25VDC
	Power consumption	50-mA maximum (with 5 VDC power supplied and three LEDs ON)
Electrical	System interface	USB
	ESD	Contact Discharge: 2, 4,6,8KV Air Discharge: 2, 4, 8,10,12.5KV
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Keycaps	Low-profile design
	Switch actuation	60±15g nominal peak force with tactile feedback
Mechanical	Switch life	10 million keystrokes (Life tester)
	Switch type	Silicon rubber switch membrane
	Cable length	6 ft (1.8 m)
	Acoustics	43-dBA maximum sound pressure level
	Temperature	Minus 20 degrees to 60 degrees Celsius
Environmental	Humidity	90%RH+-2%, 24Hours
	Vibration	3mm amplitude oscillation, 60Hz
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence

Technical Specifications – Power

Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence
Approvals	UL, FCC, CE Mark, TUV GS, VCCI, BSMI, RCM, KC, EAC
Ergonomic compliance	ISO 9241-410, TUVGS
Kit contents	

HP USB Premium Mouse

Physical characteristics	Dimensions (L x W x H)	4.21 x 2.64 x 1.52 in (107 x 67 x 38.7 mm)
	Weight w/o cable	0.19lb (90g)
	Operating temperature	50° to 122° F (10° to 50° C)
Environmental	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Electrical	Operating voltage
Power consumption (typical)		12mA
Mechanical	Connector	USB 2.0
	Type	3D mouse (3 keys and wheel)
	Resolution	800, 1200, 1600 DPI
	Sensor	Pixart PAN3606DL
	Tracking speed	30 inch/sec (max)
	Tracking acceleration	8G(max), 1G=9.8m/s ²
	Cable length	6 ft (1.8 m)
	Color	Jack Black
Regulatory Approvals	UL, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC	

HP USB Wired Keyboard

Physical characteristics	Dimensions (H x L x W)"	37mm*115mm*62.9mm
	Weight	90 +10g/- 5 g
Physical characteristics	Color	Black
	Connector	USB
	Resolution	800 DPI sensitivity
	Buttons	Two primary buttons and clickable scroll wheel

Technical Specifications – Power

AUDIO

Audio by HP Audio
Internal 2watt stereo speaker
3.5mm Combo Jack

High Definition Audio

Type	Integrated
HD Audio Codec	Conexant CX5001
Audio I/O Ports	Universal Audio Jack with CTIA headset support (re-taskable for headphone/line out/microphone in/line in)
Wavetable Syntheses	Yes - Uses OS soft wavetable
Analog Audio	Yes
Internal Speaker	Yes - two speakers
DAC Sampling Rates	44.1kHz/48kHz/96kHz/192kHz
ADC Sampling Rates	44.1kHz/48kHz/96kHz

NOTE: All performance specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

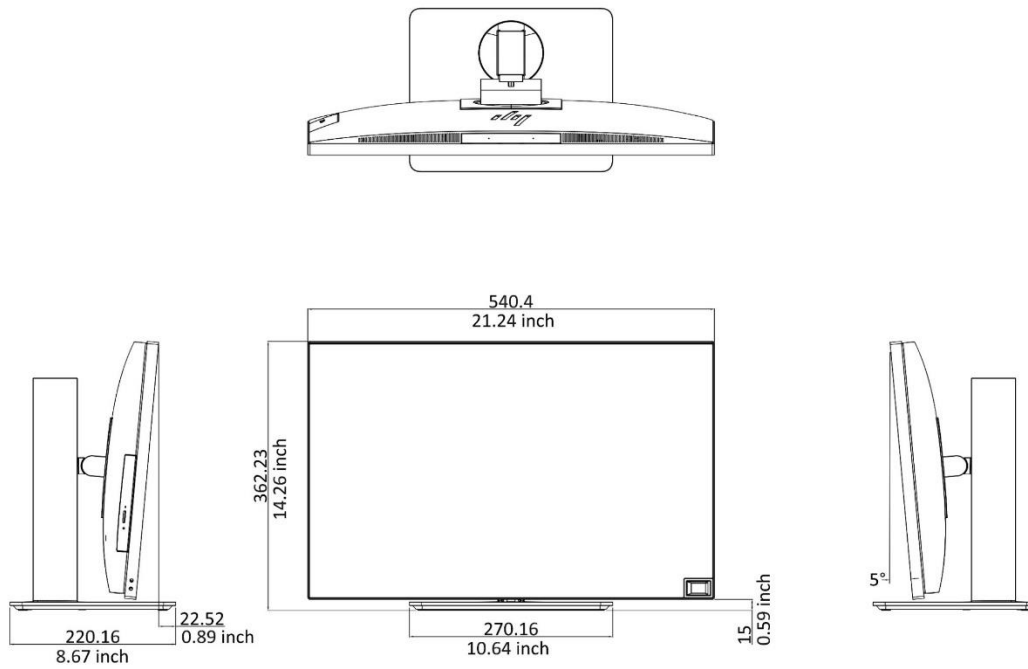
Technical Specifications – Power

POWER SUPPLY

Operating Voltage Range	90 – 264 VAC
Rated Voltage Range	100-240V AC
Rated Line Frequency	50 / 60 HZ
Operating Line Frequency	47 – 63 Hz
Rated Input Current	180 W : 2.5A
Rated Input Current with Energy Efficient* Power Supply	180 W : 2.5A 180 W active PFC 87/90/87% efficient at 20/50/100% load (115V) 88/91/88% efficient at 20/50/100% load (230V)
DC Output	12.1V/14.88A
Current Leakage (NFPA 99: 2102)	Less than 300 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1. Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.
Power cord length	6.0 ft. (1.83 m)

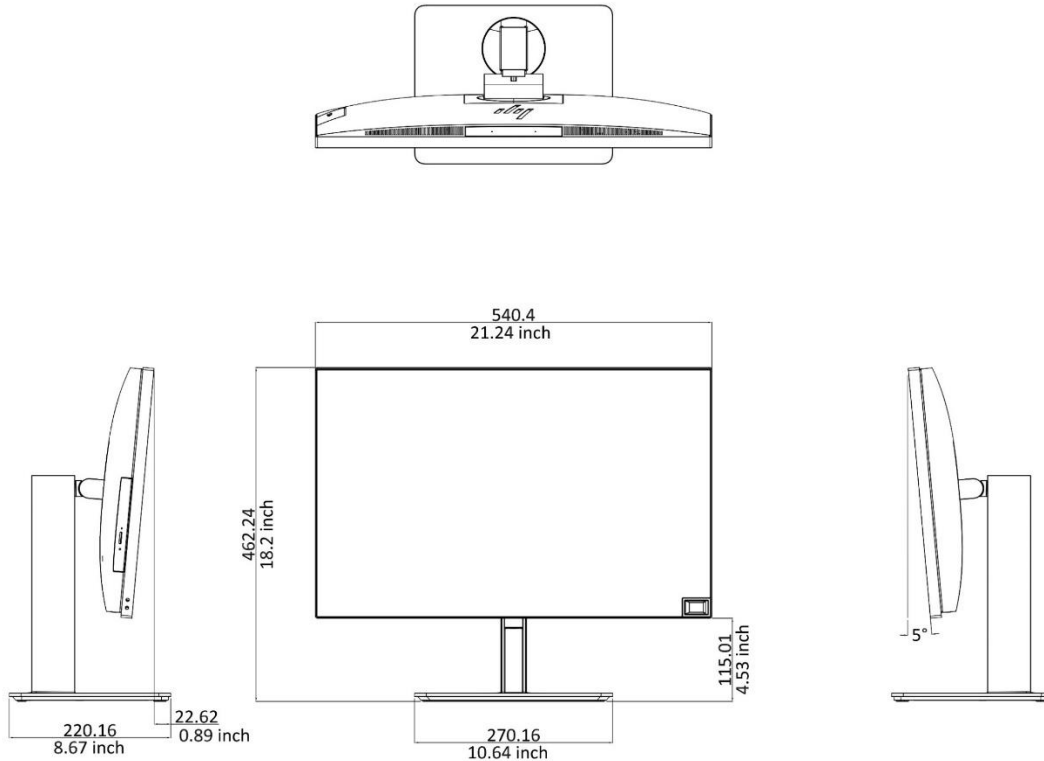
Technical Specifications – Dimensions

DIMENSIONS



Technical Specifications – Dimensions

Adjustable Height Stand Dimensions



Height - Vertical/Landscape Adjustment	101mm (±2 mm)
Portrait Adjustment	54mm (±2 mm)
Tilt Angle	5° to +20° (±3°) in landscape and portrait
Rotation (Swivel)	90° (±1°)
Pivot	Clockwise 90°

NETWORKING AND COMMUNICATIONS

Intel i219LM 10/100/1000 Integrated NIC	
Connector	RJ-45
System Interface	PCI (Intel proprietary) + SMBus
Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)
Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
Power Consumption	Cable Disconnection: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
Management Interface	Auto MDI/MDIX Crossover cable detection
IT Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
Security & Manageability	Intel® vPro™ support with appropriate Intel® chipset components
NOTE: Wireless access point and Internet service is required. Availability of public wireless access point is limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices	

Technical Specifications – Networking

Intel 9560 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 5.0 Combo vPro		
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac	
Interoperability	Wi-Fi certified	
Frequency Band	802.11b/g/n	•2.402 – 2.482 GHz
	802.11a/n	•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
Data Rates	<ul style="list-style-type: none"> •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz) 	
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
Security³	<ul style="list-style-type: none"> •IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •Cisco Certified Extensions, all versions through CCX4 and CCX Lite •WAPI 	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power²	<ul style="list-style-type: none"> • 802.11b : +18.5dBm minimum • 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum • 802.11n HT20(2.4GHz) : +15.5dBm minimum • 802.11n HT40(2.4GHz) : +14.5dBm minimum • 802.11n HT20(5GHz) : +15.5dBm minimum • 802.11n HT40(5GHz) : +14.5dBm minimum • 802.11ac VHT80(5GHz) : +11.5dBm minimum • 802.11ac VHT160(5GHz) : +11.5dBm minimum 	
Power Consumption	<ul style="list-style-type: none"> •Transmit mode2.0 W •Receive mode1.6 W •Idle mode (PSP)180 mW(WLAN Associated) •Idle mode50 mW(WLAN unassociated) •Connected Standby 10mW •Radio disabled8 mW 	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	

Technical Specifications – Networking

Receiver Sensitivity³	802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0 : -84dBm maximum 802.11ac, MCS9 : -59dBm maximum	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm	
Weight	Type 2230 : 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	14° to 158° F (-10° to 70° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology		
Bluetooth Specification	4.0/4.1/4.2/5.0 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software	
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark	

Technical Specifications – Networking

Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)
Security & Manageability	Intel® vPro™ support with appropriate Intel® chipset components
NOTE: Wireless access point and Internet service is required. Availability of public wireless access point is limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices	

Intel 9560 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 5.0 Combo non-vPro		
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac	
Interoperability	Wi-Fi certified	
Frequency Band	802.11b/g/n	•2.402 – 2.482 GHz
	802.11a/n	•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)	
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
Security³	•IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •Cisco Certified Extensions, all versions through CCX4 and CCX Lite •WAPI	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	

Technical Specifications – Networking

Output Power²	<ul style="list-style-type: none"> • 802.11b : +18.5dBm minimum • 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum • 802.11n HT20(2.4GHz) : +15.5dBm minimum • 802.11n HT40(2.4GHz) : +14.5dBm minimum • 802.11n HT20(5GHz) : +15.5dBm minimum • 802.11n HT40(5GHz) : +14.5dBm minimum • 802.11ac VHT80(5GHz) : +11.5dBm minimum • 802.11ac VHT160(5GHz) : +11.5dBm minimum 	
Power Consumption	<ul style="list-style-type: none"> • Transmit mode 2.0 W • Receive mode 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode 50 mW (WLAN unassociated) • Connected Standby 10mW • Radio disabled 8 mW 	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity³	802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0 : -84dBm maximum 802.11ac, MCS9 : -59dBm maximum	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm	
Weight	Type 2230 : 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	14° to 158° F (-10° to 70° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology		
Bluetooth Specification	4.0/4.1/4.2/5.0 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	

Technical Specifications – Networking

Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)
<p>NOTE: Wireless access point and Internet service is required. Availability of public wireless access point is limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices</p>	

Technical Specifications – Networking

Realtek 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo		
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac	
Interoperability	Wi-Fi certified	
Frequency Band	802.11b/g/n	•2.402 – 2.482 GHz
	802.11a/n	•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
Data Rates	<ul style="list-style-type: none"> •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz) 	
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
Security³	<ul style="list-style-type: none"> •IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •Cisco Certified Extensions, all versions through CCX4 and CCX Lite •WAPI 	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power²	<ul style="list-style-type: none"> • 802.11b : +14dBm minimum • 802.11g : +12dBm minimum • 802.11a : +12dBm minimum • 802.11n HT20(2.4GHz) : +12dBm minimum • 802.11n HT40(2.4GHz) : +12dBm minimum • 802.11n HT20(5GHz) : +10dBm minimum • 802.11n HT40(5GHz) : +10dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum 	
Power Consumption	<ul style="list-style-type: none"> •Transmit mode2.0 W •Receive mode1.6 W •Idle mode (PSP)180 mW(WLAN Associated) •Idle mode50 mW(WLAN unassociated) •Connected Standby 10mW •Radio disabled8 mW 	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity³	802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0 : -84dBm maximum 802.11ac, MCS9 : -59dBm maximum	

Technical Specifications – Networking

Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm	
Weight	Type 2230 : 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	14° to 158° F (–10° to 70° C)
	Non-operating	–40° to 176° F (–40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology		
Bluetooth Specification	4.0/4.1/4.2 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Bluetooth Software Supported Link Topology	USB 2.0 compliant	
Power Management	Microsoft Windows Bluetooth Software	
Certifications	Microsoft Windows ACPI, and USB Bus Support	
Power Management Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Bluetooth Profiles Supported	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark	

Technical Specifications – Networking

	<p>BT4.1-ESR 5/6/7 Compliance</p> <p>LE Link Layer Ping</p> <p>LE Dual Mode</p> <p>LE Link Layer</p> <p>LE Low Duty Cycle Directed Advertising</p> <p>LE L2CAP Connection Oriented Channels</p> <p>Train Nudging & Interlaced Scan</p> <p>BT4.2 ESR08 Compliance</p> <p>LE Secure Connection- Basic/Full</p> <p>LE Privacy 1.2 –Link Layer Privacy</p> <p>LE Privacy 1.2 –Extended Scanner Filter Policies</p> <p>LE Data Packet Length Extension</p> <p>FAX Profile (FAX)</p> <p>Basic Imaging Profile (BIP)2</p> <p>Headset Profile (HSP)</p> <p>Hands Free Profile (HFP)</p> <p>Advanced Audio Distribution Profile (A2DP)</p>
--	---

Realtek 802.11a/b/g/n/ac (1x1) WiFi and Bluetooth® 4.2 Combo ¹					
Wireless LAN Standards	<p>IEEE 802.11a</p> <p>IEEE 802.11b</p> <p>IEEE 802.11g</p> <p>IEEE 802.11n</p> <p>IEEE 802.11ac</p>				
Interoperability	Wi-Fi certified				
Frequency Band	<table border="1"> <tr> <td>802.11b/g/n</td> <td>•2.402 – 2.482 GHz</td> </tr> <tr> <td>802.11a/n</td> <td> <ul style="list-style-type: none"> •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz </td> </tr> </table>	802.11b/g/n	•2.402 – 2.482 GHz	802.11a/n	<ul style="list-style-type: none"> •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
802.11b/g/n	•2.402 – 2.482 GHz				
802.11a/n	<ul style="list-style-type: none"> •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz 				
Data Rates	<ul style="list-style-type: none"> •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz) 				
Modulation	<p>Direct Sequence Spread Spectrum</p> <p>BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM</p>				
Security³	<ul style="list-style-type: none"> •IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •Cisco Certified Extensions, all versions through CCX4 and CCX Lite •WAPI 				
Network Architecture Models	<p>Ad-hoc (Peer to Peer)</p> <p>Infrastructure (Access Point Required)</p>				
Roaming	IEEE 802.11 compliant roaming between access points				

Technical Specifications – Networking

Output Power²	<ul style="list-style-type: none"> • 802.11b : +14dBm minimum • 802.11g : +12dBm minimum • 802.11a : +12dBm minimum • 802.11n HT20(2.4GHz) : +12dBm minimum • 802.11n HT40(2.4GHz) : +12dBm minimum • 802.11n HT20(5GHz) : +10dBm minimum • 802.11n HT40(5GHz) : +10dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum 	
Power Consumption	<ul style="list-style-type: none"> • Transmit mode 2.0 W • Receive mode 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode 50 mW (WLAN unassociated) • Connected Standby 10mW • Radio disabled 8 mW 	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity³	802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0 : -84dBm maximum 802.11ac, MCS9 : -59dBm maximum	
Antenna type	High efficiency antenna. One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm	
Weight	Type 2230 : 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	14° to 158° F (-10° to 70° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology		
Bluetooth Specification	4.0/4.1/4.2 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	

Technical Specifications – Networking

Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Electrical Interface	USB 2.0 compliant
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

Options and Accessories (sold separately and availability may vary by country)

Description	Part #
HP 16GB DDR4-2666 SODIMM	3TK84AA
HP 4GB DDR4-2666 SODIMM	3TK86AA
HP 8GB DDR4-2666 SODIMM	3TK88AA
HP 256GB SATA TLC Non-SED Solid State Drive	P1N68AA
HP 500GB SATA 6G 2.5 (8GB Cache) SSHD Drive	E1C62AA
HP PCIe NVME TLC 512GB SSD M.2 Drive	X8U75AA
HP PCIe NVME TLC 256GB SSD M.2 Drive	1CA51AA
Intel Optane Memory 16GB (cache) ****	1WV97AA
HP 9.5mm Slim Removable SATA 500GB	T7G14AA
HP 9.5mm AIO 800 G3 Slim DVD Writer	Z9H62AA
HP Type-C to USB3 Adapter	N2Z63AA
HP USB-C to USB-A HUB***	Z6A00AA
HP Single Monitor Arm **	BT861AA
HP EliteOne G3 800 AIO Recline Stand	Z9H67AA
HP EliteOne G3 800 AIO Adjustable Height Stand	Z9H66AA
HP (Bulk 48) G3/4 2.5 HD/SSD M3 Grommet Screw Kit	Z9H61A6
HP Keyed Cable Lock 10mm Kit	T1A62AA
HP DVI Cable Kit	DC198A
HP DVI Cable Kit 35 unit Bulk Pack	DC198A6
HP DisplayPort To DVI-D Adapter	FH973AA
HP DisplayPort To VGA Adapter	AS615AA
HP DisplayPort Cable Kit	VN567AA
HP DisplayPort To HDMI 4k Adapter	K2K92AA
HP DisplayPort to Dual Link DVI Adapter	NR078AA
HP DisplayPort To HDMI True 4k Adapter	2JA63AA
HP USB Graphics Adapter	NL571AA
HP USB Graphics Adapter	NL571AT
HP HDMI Standard Cable Kit	T6F94AA
HP Business Headset v2	T4E61AA
HP UC Wireless Duo Headset	W3K09AA
HP USB Grey v2 Mouse	Z9H74AA
HP USB Mouse	QY777AA
HP (Bulk) USB Mouse	QY777A6
HP USB Grey Mouse	K7W54AA
HP USB 1000dpi Laser Mouse	QY778AA
HP (Bulk) USB 1000dpi Laser Mouse	QY778A6
HP PS/2 Mouse	QY775AA
HP (Bulk) PS/2 Mouse	QY775A6
HP Mouse Pad	AT485AA
HP (Bulk) Mouse Pad	AT485A6
HP USB PS/2 Washable Scroll Mouse	BM866AA
HP USB Hardened Mouse	P1N77AA
HP USB Collaboration Keyboard	Z9N38AA

Options and Accessories (sold separately and availability may vary by country)

HP WLess Collaboration Keyboard	Z9N39AA
HP USB Premium Keyboard	Z9N40AA
HP WLess Premium Keyboard	Z9N41AA
HP Bus Slim Wireless Localize Kit Nordic	ZMY27AA
HP Bus Slim Localize Kit - Nordic USB	ZMY28AA
HP USB Keyboard and Mouse Healthcare Edition	1VD81AA
HP Business Slim Smartcard Keyboard	Z9H48AA
HP USB (Grey) Business Slim Keyboard	Z9H49AA
HP USB Antimicrobial Slim Keyboard and Mouse	Z9H50AA
HP Conferencing Keyboard	K8P74AA
HP USB Conferencing Keyboard	N8N57AA
HP Wireless Keyboard & Mouse	QY449AA
HP USB Keyboard	QY776AA
HP USB Keyboard/Mouse/Mousepad Kit	B1T09AA
HP (Bulk Pack) USB Keyboard	QY776AT
HP USB (Grey) Keyboard	B6B64AA
HP (Bulk Pack) USB (Grey) Keyboard	B6B64A6
HP PS/2 Keyboard	QY774AA
HP (Bulk Pack) PS/2 Keyboard	QY774A6
HP (Bulk Pack) USB Smart Card Keyboard	ED707A6#xxx
HP USB CCID Smartcard Keyboard	BV813AA#xxx
HP (Bulk Pack) USB CCID Smart Card Keyboard	BT824A6#xxx
HP USB PS2 Washable Keyboard	VF097AA#xxx
HP USB PS2 Washable Keyboard & Mouse	BU207AA#xxx
HP USB Smartcard CCID Keyboard	E6D77AA#xxx
HP (Bulk) USB Smartcard CCID Keyboard	E6D77A6#xxx
HP USB Grey Smartcard CCID Keyboard	J7H70AA#xxx
HP (Bulk) PS/2 Business Slim Keyboard	N3R86A6
HP USB Business Slim Keyboard	N3R87AA
HP (Bulk) USB Business Slim Keyboard	N3R87A6
HP Wireless Business Slim Keyboard and Mouse	N3R88AA
HP (Bulk) Wireless Business Slim Keyboard and Mouse	N3R88A6
HP USB Business Slim Keyboard and Mouse and MousePad	T4E63AA
HP (Bulk) USB Bus Slim Keyboard/Mouse/Mousepad	T4E63A6

Summary of Changes

Date of change:	Version History:		Description of change:
	V1 to V2		
February 5, 2019	V2 to V3	Update	HP PhoneWise, HP ePrinter + Jet advantage, HP Velocity, and HP WorkWise removed / Windows Defender and Sure Click disclaimers updated
November 11, 2019	V3 to V4	Update	EPEAT references updated

Copyright © 2019 HP Development Company, L.P. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Bluetooth is a trademark of its proprietor and used by HP Inc. under license. Intel, Core and Intel vPro are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. USB Type-C™ and USB-C™ are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency.

DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries.